

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image





Similar to illustration

The new benchmark for component density: the virtual 0.875mm pitch - for 1mm² I/O connections

The only 4-row double level male connectors for standard IP20 sensor interfaces with 3.5 pitch

The S2L in a double pack - a standard has surpassed itself:

- Each 3.5mm wide, 4 I/O contacts for 1mm² connection cross-section
- Force-fit enclosure geometry guarantees maximum stability
- · Solder flange eliminates the need for a screw fastening

Less is more - basic advantages for your applications:

- 75% space savings on the circuit board
- Solder flange reduces process costs
- Less mechanical load on the soldering points
- More space for displays in the front panel, for example

A "small" contribution to greater competitiveness: additional features in the same installation space or a more compact device with the same range of functions.

General ordering data

Packaging	Вох
Product data	IEC: 200 V / 7.9 A UL: 150 V / 9.5 A
Qty.	20 pc(s).
GTIN (EAN)	4050118160666
Туре	S2CD-THR 3.50/24/90G 3.2SN BK BX
Order No.	<u>1357840000</u>
Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 24, 90°, Solder pin length (I): 3.2 mm, tinned, black, Box



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Technical data

Depth	24.4 mm	Depth (inches)	0.961 inch
Height	35 mm	Height (inches)	1.378 inch
Height of lowest version	31.8 mm	Net weight	13.1 g
Width	22.4 mm	Width (inches)	0.882 inch

System specifications

Product family	OMNIMATE Signal - series B2C/S2C 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	0.5
	connection		3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°
Number of poles	24	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm	
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	38.5 mm	L1 in inches	1.516 inch
Pin series quantity		Touch-safe protection acc. to DIN VE	DE
	2	57 106	Safe from finger touch
Touch-safe protection acc. to DIN VI	DE	Can be coded	
0470	IP 20		Yes

Material data

Insulating material	LCP GF
Colour chart (similar)	RAL 9011
Comparative Tracking Index (CTI)	≥ 175
UL 94 flammability rating	V-0
Contact surface	
	tinned
Layer structure of plug contact	25 µm Sn / 13 µm Ni
Layer structure of plug contact Storage temperature, max.	25 µm Sn / 13 µm Ni 70 °C

Colour	black
Insulating material group	IIIb
Moisture Level (MSL)	1
Contact material	Copper alloy
Layer structure of solder connection	13 µm Ni / 25 µm Sn
	matt
Storage temperature, min.	-40 °C
Operating temperature, min.	-50 °C
Temperature range, installation, min.	-40 °C

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	7.9 A
Rated current, max. number of poles (Tu=20°C)	5 A	Rated current, min. number of poles (Tu=40°C)	6.8 A
Rated current, max. number of poles (Tu=40°C)	5 A	Rated voltage for surge voltage class / pollution degree II/2	200 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	100 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	1.5 kV	Short-time withstand current resistance	3 x 1s with 80 A



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200039-1121690

50 V

9.5 A

5 A

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Technical data

Rated data acc. to CSA		
Institute (CSA)		



Rated voltage (Use group B / CSA)	50 V
Rated voltage (Use group D / CSA)	150 V
Rated current (Use group C / CSA)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.

Rated data acc. to UL 1059

Institute (cURus)

	c RL us	
))	150 V	
2	501/	

Rated voltage (Use group B / UL 1059)	150 V
Rated voltage (Use group D / UL 1059)	50 V
Rated current (Use group C / UL 1059)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.

Certificate No. (cURus)

Certificate No. (CSA)

Rated voltage (Use group C / CSA)

Rated current (Use group B / CSA)

Rated current (Use group D / CSA)

	E60693
Rated voltage (Use group C / UL 1059)	50 V
Rated current (Use group B / UL 1059)	9.5 A
Rated current (Use group D / UL 1059)	9.5 A

Packing

VPE width 105 mm VPE height	
VPE width 105 mm VPE height	140 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Gold-plated contact surfaces on request
	Rated current related to rated cross-section & min. No. of poles.
	Spacing between rows: see hole layout
	• P on drawing = pitch
	• Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
	• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months



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Germany www.weidmueller.com

Technical data

Approvals		
Approvals		
ROHS	Conform	
UL File Number Search	E60693	
Downloads		
Approval/Certificate/Document of		
Conformity	Declaration of the Manufacturer	
Engineering Data	STEP	

Drawings

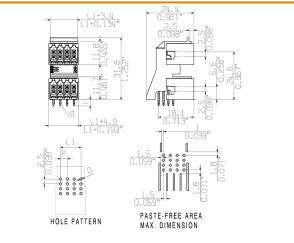


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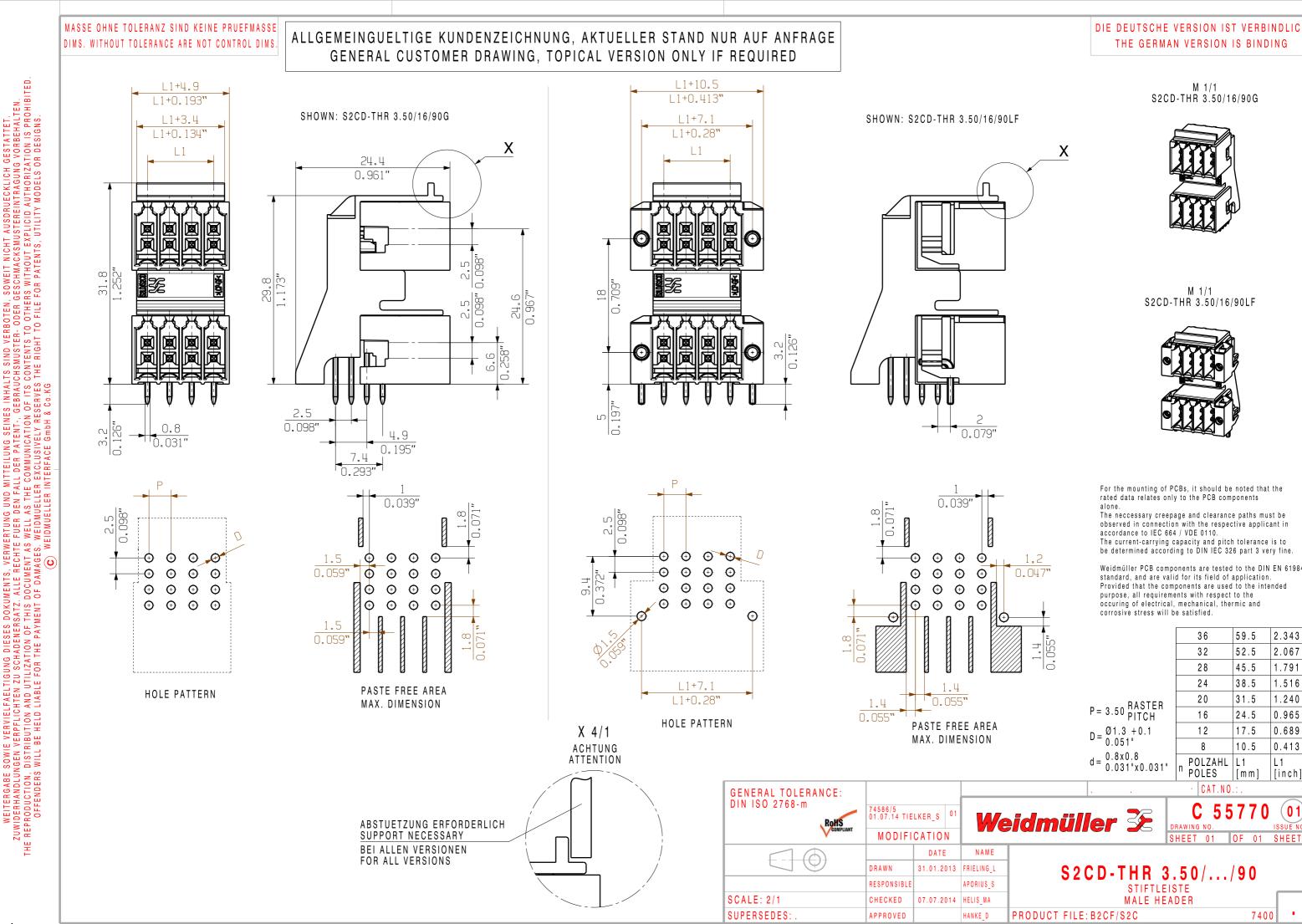
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Dimensional drawing

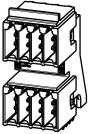


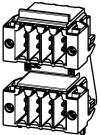
Creation date March 23, 2021 6:31:25 PM CET

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DIE DEUTSCHE VERSION IST VERBINDLICH





Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application.

2.343 2.067 1.791 1.516 1.240 0.965 0.689 0.413



Wave Solder Profile

Recommended wave solderding profiles

Weidmüller 🟵

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Double Wave:

Single Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Reflow Solder Profile

Recommended reflow soldering profile



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Time [sec]

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.